

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
WEI ZHANG	01/14/2019
MING SHI	01/14/2019
XIAOZHI FU	01/14/2019
DINGBING FAN	01/14/2019
HONGTAO JIANG	01/14/2019
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<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16240011
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<b>SIGNATURE:</b>	/Salvatore Anastasi/
<b>DATE SIGNED:</b>	01/14/2019
<b>Total Attachments: 1</b>	



**COMBINED DECLARATION AND ASSIGNMENT**

As a below-named inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

- the attached application, or
- United States application or PCT international application number 16/240,011 filed on 04 January, 2019 entitled Plug-In Type Wire to Wire Connector (“the APPLICATION”)

The APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

*Tyco Electronics (Shanghai) Co. Ltd.* (“ASSIGNEE”), a corporation organized and existing under and by virtue of the laws of *China* having its principal place of business at *Sections F and G, Level 1, Building 15, No. 999, Yinglun Road, China (Shanghai) Pilot Free Trade Zone, Shanghai, China,*

for a valuable consideration, the receipt of which is hereby acknowledged, **I do hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns,** my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment

Legal Name	Signature	Date
ZHANG, Wei	<i>Zhang, wei</i>	<i>2019. 1. 14</i>
SHI, Ming	<i>Shi Ming</i>	<i>2019. 1. 14</i>
FU, Xiaozhi	<i>Fu, Xiaozhi</i>	<i>2019. 1. 14</i>
FAN, Dingbing	<i>Fan Dingbing</i>	<i>2019. 1. 14</i>
JIANG, Hongtao	<i>Jiang, Hongtao</i>	<i>2019. 1. 14</i>